



June 1997  
Revised October 1998

## GTLP16617

### 17-Bit TTL/GTLP Synchronous Bus Transceiver with Buffered Clock

#### General Description

The GTLP16617 is a 17-bit registered synchronous bus transceiver that provides TTL to GTLP signal level translation. It allows for transparent, latched and clocked modes of data flow and provides a buffered GTLP (CLKOUT) clock output from the TTL CLKAB. The device provides a high speed interface between cards operating at TTL logic levels and a backplane operating at GTLP logic levels. High speed backplane operation is a direct result of GTLP's reduced output swing (<1V), reduced input threshold levels and output edge rate control. The edge rate control minimizes bus settling time. GTLP is a Fairchild Semiconductor derivative of the Gunning Transceiver logic (GTL) JEDEC standard JESD8-3.

Fairchild's GTLP has internal edge-rate control and is process, voltage, and temperature (PVT) compensated. Its function is similar to BTL and GTL but with different output levels and receiver threshold. GTLP output LOW level is typically less than 0.5V, the output level HIGH is 1.5V and the receiver threshold is 1.0V.

#### Features

- Bidirectional interface between GTLP and TTL logic levels
- Edge Rate Control to minimize noise on the GTLP port
- Power up/down/off high impedance for live insertion.
- External  $V_{REF}$  pin for receiver threshold
- CMOS technology for low power dissipation
- 5 V tolerant inputs and outputs on the A-Port
- Bus-hold data inputs on the A-Port eliminates the need for external pull-up resistors on unused inputs.
- TTL compatible driver and control inputs
- Flow through pinout optimizes PCB layout
- Open drain on GTLP to support wired-or connection
- A-Port source/sink -32 mA/+32 mA
- D-type flip-flop, latch and transparent data paths
- GTLP Buffered CLKAB signal available(CLKOUT)
- Recommended Operating Temperature -40°C to 85°C

#### Ordering Code:

Order Number	Package Number	Package Description
GTLP16617MEA	MS56A	56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118 0.300" Wide
GTLP16617MTD	MTD56	56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

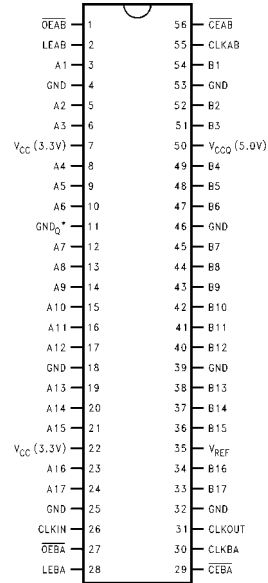
Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

GTLP16617 17-Bit TTL/GTLP Synchronous Bus Transceiver with Buffered Clock

## Pin Descriptions

Pin Names	Description
$\overline{OEAB}$	A-to-B Output Enable (Active LOW)
$\overline{OEBA}$	B-to-A Output Enable (Active LOW)
$\overline{CEAB}$	A-to-B Clock Enable (Active LOW)
$\overline{CEBA}$	B-to-A Clock Enable (Active LOW)
LEAB	A-to-B Latch Enable (Transparent HIGH)
LEBA	B-to-A Latch Enable (Transparent HIGH)
$V_{REF}$	GTLP Reference Voltage
CLKAB	A-to-B Clock
CLKBA	B-to-A Clock
A1-A17	A-to-B Data Inputs or B-to-A 3-STATE Data Outputs
B1-B17	B-to-A Data Inputs or A-to-B Open Drain Outputs
CLKIN	B-to-A Buffered Clock Output
CLKOUT	GTLP Buffered Clock Output of CLKAB

## Connection Diagram



## Functional Description

The GTLP16617 is a 17 bit registered transceiver containing D-type flip-flop, latch and transparent modes of operation for the data path and a GTLP translation of the CLKAB signal (CLKOUT). Data flow in each direction is controlled by the clock enables ( $\overline{CEAB}$  and  $\overline{CEBA}$ ), latch enables (LEAB and LEBA), clock (CLKAB and CLKBA) and output enables ( $\overline{OEAB}$  and  $\overline{OEBA}$ ). The clock enables ( $\overline{CEAB}$  and  $\overline{CEBA}$ ) enable all 17 data bits. The output enables ( $\overline{OEAB}$  and  $\overline{OEBA}$ ) control both the 17 bits of data and the CLKOUT/CLKIN buffered clock paths and the  $\overline{OEAB}$  is synchronous with the CLKAB signal. The  $\overline{OEBA}$  can not be synchronous since we are passing the clock through the device with data and we would need to generate the CLKBA signal elsewhere. It should also be noted that the  $\overline{OEAB}$  register is controlled by CLKAB only, and is also not inhibited by the  $\overline{CEAB}$  signal.

For A-to-B data flow, when  $\overline{CEAB}$  is LOW, the device operates on the LOW-to-HIGH transition of CLKAB for the flip-flop and on the HIGH-to-LOW transition of LEAB for the latch path. That is, if  $\overline{CEAB}$  is LOW and LEAB is LOW the A data is latched regardless as to the state of CLKAB (HIGH or LOW) and if LEAB is HIGH the device is in transparent mode. When  $\overline{OEAB}$  is registered LOW the outputs are active. When  $\overline{OEAB}$  is registered HIGH the outputs are HIGH impedance. The data flow of B-to-A is similar except that  $\overline{CEBA}$ ,  $\overline{OEBA}$ , LEBA and CLKBA are used.

## Truth Table

(Note 1)

Inputs					Output B	Mode
$\overline{CEAB}$	$\overline{OEAB}$ (Note 2)	LEAB	CLKAB	A		
X	H	X	$\uparrow$	X	Z (Note 3)	Latched storage of A data
L	L	L	H or L	X	$B_0$ (Note 4)	
L	L	L	H or L	X	(Note 5)	
X	L	H	X	L	L	Transparent
X	L	H	X	H	H	
L	L	L	$\uparrow$	L	L	Clocked storage of A data
L	L	L	$\uparrow$	H	H	
H	L	L	X	X	$B_0$ (Note 5)	Clock inhibit

**Note 1:** A-to-B data flow is shown. B-to-A data flow is similar but uses  $\overline{OEBA}$ , LEBA, CLKBA,  $\overline{CEBA}$ .

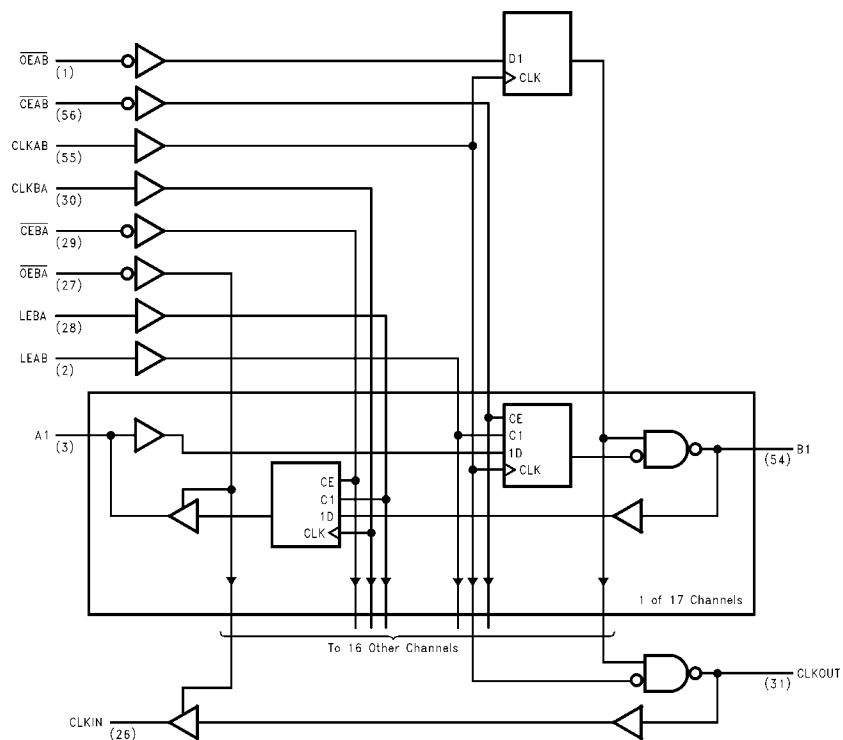
**Note 2:** LH edge on CLKAB is required when changing the input on  $\overline{OEAB}$  pin.

**Note 3:**  $\overline{OEAB}$  met set-up time prior to CLKAB LH transition

**Note 4:** Output level before the indicated steady state input conditions were established, provided CLKAB was HIGH prior to LEAB going LOW.

**Note 5:** Output level before the indicated steady state input conditions were established.

# Logic Diagram



**Absolute Maximum Ratings** (Note 6)

Supply Voltage ( $V_{CC}$ )	–0.5V to +7.0V
DC Input Voltage ( $V_I$ )	–0.5V to +7.0V
DC Output Voltage ( $V_O$ )	
Outputs 3-STATE	–0.5V to +7.0V
Outputs Active (Note 7)	–0.5V to $V_{CC} + 0.5V$
DC Output Sink Current into	
A-Port $I_{OL}$	64 mA
DC Output Source Current from	
A-Port $I_{OH}$	–64 mA
DC Output Sink Current	
into B-Port in the LOW State,	
$I_{OL}$	80 mA
DC Input Diode Current ( $I_{IK}$ )	
$V_I < 0V$	–50 mA
DC Output Diode Current ( $I_{OK}$ )	
$V_O < 0V$	–50 mA
$V_O > V_{CC}$	+50 mA
ESD Rating	>2000V
Storage Temperature ( $T_{STG}$ )	–65°C to +150°C

**Recommended Operating Conditions** (Note 8)

Supply Voltage $V_{CC}$	3.15V to 3.45V
$V_{CCQ}$	4.75V to 5.25V
Bus Termination Voltage ( $V_{TT}$ ) GTLP	1.35V to 1.65V
Input Voltage ( $V_I$ )	
on A-Port and Control Pins	0.0V to 5.5V
HIGH Level Output Current ( $I_{OH}$ )	
A-Port	–32 mA
LOW Level Output Current ( $I_{OL}$ )	
A-Port	+32 mA
B-Port	+34 mA
Operating Temperature ( $T_A$ )	–40°C to +85°C

**Note 6:** The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

**Note 7:**  $I_O$  Absolute Maximum Rating must be observed.

**Note 8:** Unused inputs must be held high or low.

DC Electrical Characteristics							
Over Recommended Operating Free-Air Temperature Range, $V_{REF} = 1.0V$ (Unless Otherwise Noted).							
Symbol		Test Conditions		Min	Typ (Note 9)	Max	Units
$V_{IH}$	B-Port			$V_{REF} + 0.1$		$V_{TT}$	V
	Others			2.0			V
$V_{IL}$	B-Port			0.0		$V_{REF} - 0.2$	V
	Others					0.8	V
$V_{REF}$	GTLP				1.0		V
	GTL				0.8		V
$V_{IK}$		$V_{CC} = 3.15V$ , $V_{CCQ} = 4.75V$	$I_I = -18\text{ mA}$			-1.2	V
$V_{OH}$	A-Port	$V_{CC}, V_{CCQ} = \text{Min to Max (Note 10)}$	$I_{OH} = -100\text{ }\mu A$	$V_{CC} - 0.2$			V
		$V_{CC} = 3.15V$	$I_{OH} = -8\text{ mA}$	2.4			
		$V_{CCQ} = 4.75V$	$I_{OH} = -32\text{ mA}$	2.0			
$V_{OL}$	A-Port	$V_{CC}, V_{CCQ} = \text{Min to Max (Note 10)}$	$I_{OL} = 100\text{ }\mu A$			0.2	V
		$V_{CC} = 3.15V$	$I_{OL} = 32\text{ mA}$			0.5	
		$V_{CCQ} = 4.75V$					
	B-Port	$V_{CC} = 3.15V\ V_{CCQ} = 4.75V$	$I_{OL} = 34\text{ mA}$			0.65	V
$I_I$	Control Pins	$V_{CC}, V_{CCQ} = 0\text{ or Max}$	$V_I = 5.5V\text{ or }0V$			$\pm 10$	$\mu A$
	A-Port	$V_{CC} = 3.45V$ $V_{CCQ} = 5.25V$	$V_I = 5.5V$			20	$\mu A$
			$V_I = V_{CC}$			1	
			$V_I = 0$			-30	
	B-Port	$V_{CC} = 3.45V$ $V_{CCQ} = 5.25V$	$V_I = V_{CCQ}$			5	$\mu A$
$V_I = 0$					-5		
$I_{OFF}$	A-Port and Control Pins	$V_{CC} = V_{CCQ} = 0$	$V_I\text{ or }V_O = 0\text{ to }4.5V$			100	$\mu A$
$I_{I(\text{hold})}$	A-Port	$V_{CC} = 3.15V$ , $V_{CCQ} = 4.75V$	$V_I = 0.8V$	75			$\mu A$
			$V_I = 2.0V$	-20			
$I_{OZH}$	A-Port	$V_{CC} = 3.45V$ ,	$V_O = 3.45V$			1	$\mu A$
	B-Port	$V_{CCQ} = 5.25V$	$V_O = 1.5V$			5	
$I_{OZL}$	A-Port	$V_{CC} = 3.45V$ ,	$V_O = 0$			-20	$\mu A$
	B-Port	$V_{CCQ} = 5.25V$	$V_O = 0.65V$			-10	
$I_{CCQ}$ ( $V_{CCQ}$ )	A or B Ports	$V_{CC} = 3.45V$ , $V_{CCQ} = 5.25V$ , $I_O = 0$ , $V_I = V_{CCQ}\text{ or GND}$	Outputs HIGH		30	40	mA
			Outputs LOW		30	40	
			Outputs Disabled		30	40	
$I_{CC}$ ( $V_{CC}$ )	A or B Ports	$V_{CC} = 3.45V$ , $V_{CCQ} = 5.25V$ , $I_O = 0$ , $V_I = V_{CCQ}\text{ or GND}$	Outputs HIGH		0	1	mA
			Outputs LOW		0	1	
			Outputs Disabled		0	1	
$\Delta I_{CC}$ (Note 11)	A-Port and Control Pins	$V_{CC} = 3.45V$ , $V_{CCQ} = 5.25V$ , A or Control Inputs at $V_{CC}\text{ or GND}$	One Input at 2.7V		0	1	mA
$C_{IN}$	Control Pins		$V_I = V_{CCQ}\text{ or }0$		8		pF
$C_{IO}$	A-Port		$V_I = V_{CCQ}\text{ or }0$		9		
$C_{IO}$	B-Port		$V_I = V_{CCQ}\text{ or }0$		6		
<b>Note 9:</b> All typical values are at $V_{CC} = 3.3V$ , $V_{CCQ} = 5.0V$ , and $T_A = 25^\circ C$ .							
<b>Note 10:</b> For conditions shown as Min or Max, use the appropriate value specified under recommended operating conditions.							
<b>Note 11:</b> This is the increase in supply current for each input that is at the specified TTL voltage level rather than $V_{CC}$ or GND.							

## AC Operating Requirements

Over recommended ranges of supply voltage and operating free-air temperature,  $V_{REF} = 1.0V$  (unless otherwise noted).

Symbol		Min	Max	Unit
$f_{CLOCK}$	Max Clock Frequency	175		MHz
$t_W$	Pulse Duration	LEAB or LEBA HIGH	3.0	ns
		CLKAB or CLKBA HIGH or LOW	3.2	
$t_S$	Setup Time	A before CLKAB $\uparrow$	0.5	ns
		$\overline{OEAB}$ before CLKAB $\uparrow$	1.5	
		B before CLKBA $\uparrow$	3.1	
		A before LEAB $\downarrow$	1.3	
		B before LEBA $\downarrow$	3.7	
		$\overline{CEAB}$ before CLKAB $\uparrow$	0.7	
		$\overline{CEBA}$ before CLKBA $\uparrow$	1.0	
$t_H$	Hold Time	A after CLKAB $\uparrow$	1.5	ns
		$\overline{OEAB}$ after CLKAB $\uparrow$	1.0	
		B after CLKBA $\uparrow$	0.0	
		A after LEAB $\downarrow$	0.5	
		B after LEBA $\downarrow$	0.0	
		$\overline{CEAB}$ after CLKAB $\uparrow$	1.5	
		$\overline{CEBA}$ after CLKBA $\uparrow$	1.7	

## AC Electrical Characteristics

Over recommended range of supply voltage and operating free-air temperature,  $V_{REF} = 1.0V$  (unless otherwise noted).  $C_L = 30\text{ pF}$  for B-Port and  $C_L = 50\text{ pF}$  for A-Port.

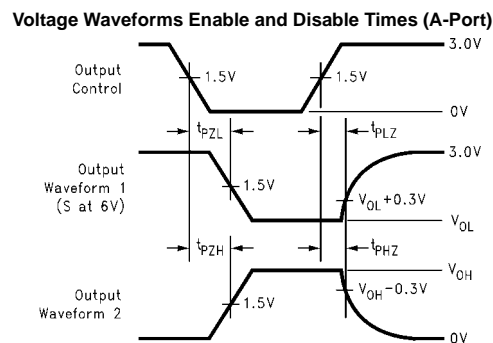
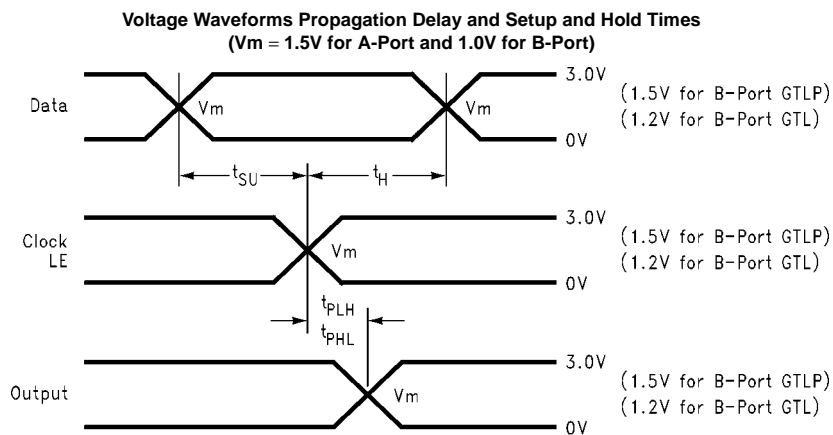
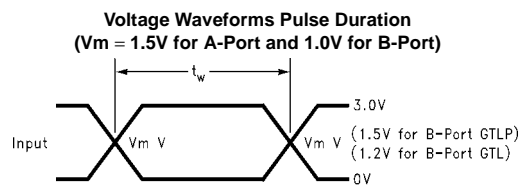
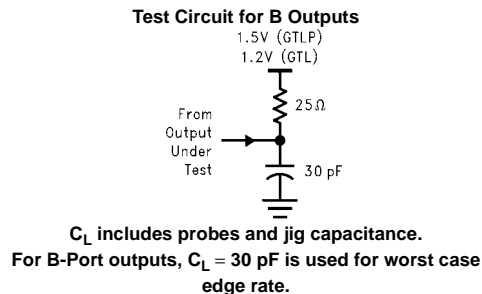
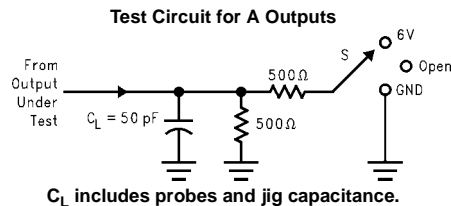
Symbol	From (Input)	To (Output)	Min	Typ (Note 12)	Max	Unit
$t_{PLH}$	A	B	1.0	4.3	6.5	ns
$t_{PHL}$			1.0	5.0	8.2	
$t_{PLH}$	LEAB	B	1.8	4.5	6.7	ns
$t_{PHL}$			1.5	5.3	8.7	
$t_{PLH}$	CLKAB	B	1.8	4.6	6.7	ns
$t_{PHL}$			1.5	5.4	8.7	
$t_{PLH}$	CLKAB	CLKOUT	3.0	6.2	10.0	ns
$t_{PHL}$			3.0	5.7	10.0	
$t_{PLH}$	$\overline{OEAB}$ (CLKAB) (Note 13)	B	1.6	4.4	8.0	ns
$t_{PHL}$			1.3	6.1	9.8	
$t_{SKEW}$	B (Note 14)	CLKOUT	0		2	ns
$t_{RISE}$	Transition time, B outputs (20% to 80%)			2.6		ns
$t_{FALL}$	Transition time, B outputs (20% to 80%)			2.6		
$t_{PLH}$	B	A	2.0	5.6	8.2	ns
$t_{PHL}$			1.4	5.0	7.2	
$t_{PLH}$	LEBA	A	2.1	4.2	6.3	ns
$t_{PHL}$			1.9	3.3	5.0	
$t_{PLH}$	CLKBA	A	2.3	4.4	6.8	ns
$t_{PHL}$			2.1	3.5	5.2	
$t_{PLH}$	CLKOUT	CLKIN	3.0	6.0	10.0	ns
$t_{PHL}$			3.0	6.43	10.0	
$t_{PZH}, t_{PZL}$	$\overline{OEBA}$	A or CLKIN	1.5	5.0	6.4	ns
$t_{PHZ}, t_{PLZ}$			1.4	3.9	8.0	

**Note 12:** All typical values are at  $V_{CC} = 3.3V$ ,  $V_{CCQ} = 5.0V$ , and  $T_A = 25^\circ C$ .

**Note 13:** Three-state delays are actually synchronous with CLKAB

**Note 14:** Skew is defined as the absolute value of the difference between the actual propagation delays for the CLKOUT pin and any B output transition when measured with reference to CLKAB $\uparrow$ . This guarantees the relationship between B output data and CLKOUT such that data is coincident or ahead of CLKOUT. This specification is guaranteed but not tested.

## Test Circuits and Timing Waveforms

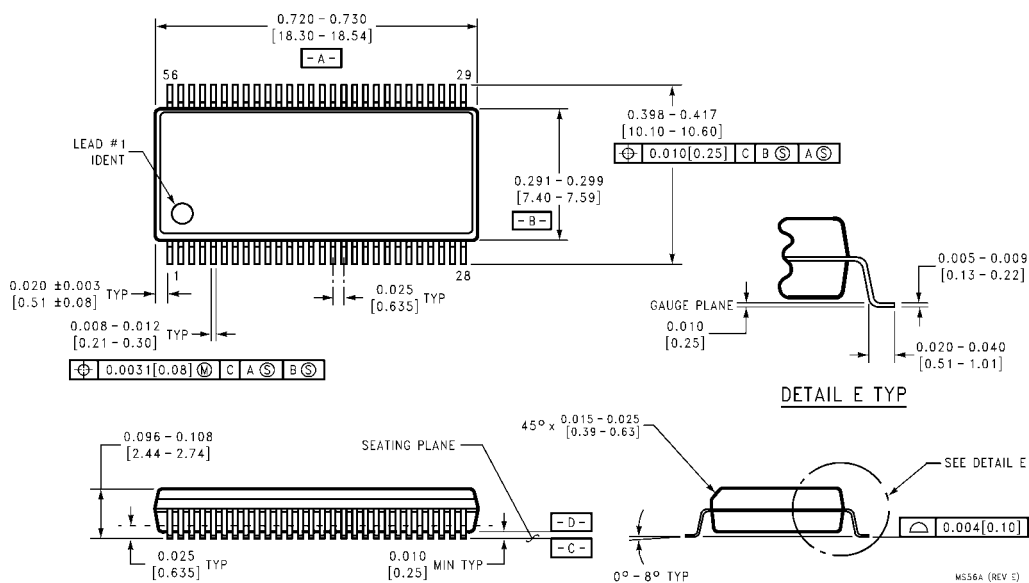


Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

All input pulses have the following characteristics: frequency = 10 MHz,  $t_r = t_f = 2 \text{ ns}$ ,  $Z_O = 50\Omega$ . The outputs are measured one at a time with one transition per measurement.



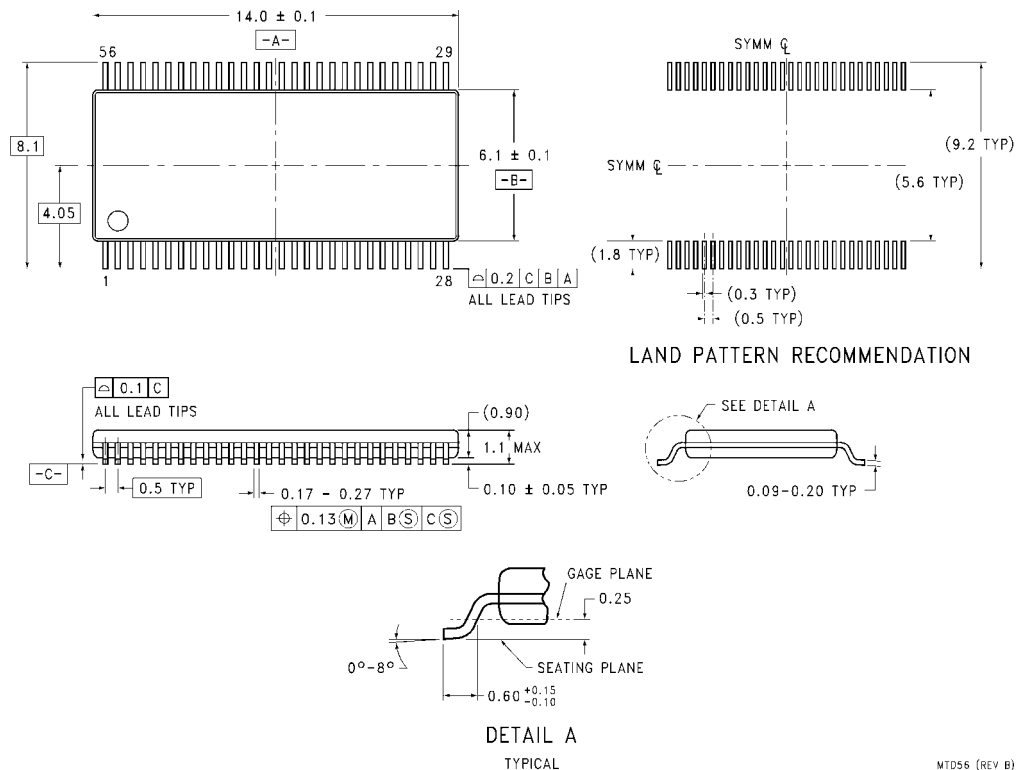
# **Physical Dimensions** inches (millimeters) unless otherwise noted



**56-Lead Shrink Small Outline Package, JEDEC MO-118 0.300" Wide  
Package Number MS56A**

## Physical Dimensions

inches (millimeters) unless otherwise noted (Continued)



56-Lead Thin Shrink Small Outline Package, JEDEC MO-153, 6.1mm Wide  
Package Number MTD56

MTD56 (REV B)

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